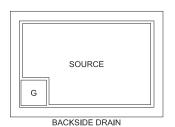


CP373-CMPDM303NH

N-Channel MOSFET Die Enhancement-Mode

The CP373-CMPDM303NH is a silicon N-Channel MOSFET designed for high speed pulsed amplifier and driver applications.



MECHANICAL SPECIFICATIONS:

Die Size	39 x 27 MILS
Die Thickness	7.5 MILS
Gate Bonding Pad Size	6.5 x 6.5 MILS
Source Bonding Pad Size	33 x 21 MILS
Top Side Metalization	AI – 40,000Å
Back Side Metalization	Ti/Ni/Ag - 1,000Å/3,000Å/10,000Å
Scribe Alley Width	3.15 MILS
Wafer Diameter	8 INCHES
Gross Die Per Wafer	43,500

MAXIMUM RATINGS: (T _A =25°C)	SYMBOL		UNITS
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	12	V
Continuous Drain Current (Steady State)	I_{D}	3.6	Α
Maximum Pulsed Drain Current, tp=10µs	I_{DM}	14.4	Α
Operating and Storage Junction Temperature	T _{.J} , T _{sta}	-55 to +150	°C

ELECTRICAL CHARACTERISTICS: (T_A=25°C unless otherwise noted)

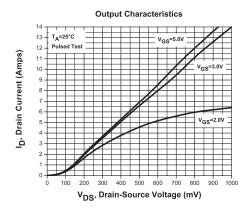
SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
I _{GSSF} , I _{GSSR}	V_{GS} =12V, V_{DS} =0			10	μΑ
IDSS	V_{DS} =20V, V_{GS} =0			1.0	μΑ
BV _{DSS}	V _{GS} =0, I _D =250μA	30			V
V _{GS(th)}	$V_{GS}=V_{DS}$, $I_{D}=250\mu A$	0.6		1.2	V
rDS(ON)	V_{GS} =4.5V, I_D =1.8A			0.04	Ω
r _{DS(ON)}	V_{GS} =2.5V, I_D =1.8A			0.078	Ω
9FS	V_{DS} =5.0V, I_{D} =3.6A		11.8		S
C _{rss}	V_{DS} =10V, V_{GS} =0, f=1.0MHz		55		pF
C _{iss}	V_{DS} =10V, V_{GS} =0, f=1.0MHz		590		pF
C _{oss}	V_{DS} =10V, V_{GS} =0, f=1.0MHz		50		pF
Q _{g(tot)}	V_{DD} =10V, V_{GS} =4.5V, I_{D} =3.6A			13	nC
Q_{gs}	V_{DD} =10V, V_{GS} =4.5V, I_{D} =3.6A			1.4	nC
Q_{gd}	V_{DD} =10V, V_{GS} =4.5V, I_{D} =3.6A			2.7	nC
ton	V_{DD} =10V, V_{GS} =4.0V, I_{D} =3.6A, R_{G} =10 Ω		15		ns
t _{off}	V_{DD} =10V, V_{GS} =4.0V, I_{D} =3.6A, R_{G} =10 Ω		29		ns

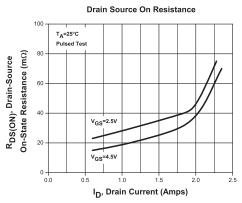
CP373-CMPDM303NH

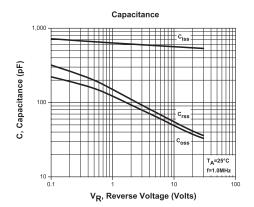
Typical Electrical Characteristics

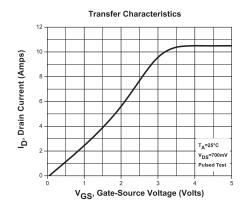


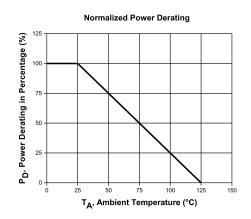
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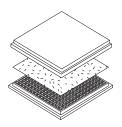




R0 (23-March 2018)

BARE DIE PACKING OPTIONS

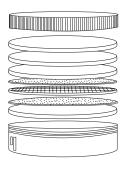




BARE DIE IN TRAY (WAFFLE) PACK

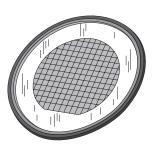
CT: Singulated die in tray (waffle) pack. (example: CP211-PART NUMBER-CT)

CM: Singulated die in tray (waffle) pack 100% visually inspected as per MIL-STD-750, (method 2072 transistors, method 2073 diodes). (example: CP211-PART NUMBER-CM)



UNSAWN WAFER

WN: Full wafer, unsawn, 100% tested with reject die inked. (example: CP211-PART NUMBER-WN)



SAWN WAFER ON PLASTIC RING

WR: Full wafer, sawn and mounted on plastic ring, 100% tested with reject die inked.

(example: CP211-PART NUMBER-WR)

Please note: Sawn Wafer on Metal Frame (WS) is possible as a special order. Please contact your Central Sales Representative at 631-435-1110.



Visit the Central website for a complete listing of specifications: www.centralsemi.com/bdspecs

R2 (3-April 2017)

OUTSTANDING SUPPORT AND SUPERIOR SERVICES



PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- · Inventory bonding
- · Consolidated shipping options

- · Custom bar coding for shipments
- · Custom product packing

DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free guick ship samples (2nd day air)
- Online technical data and parametric search
- SPICE models
- · Custom electrical curves
- · Environmental regulation compliance
- · Customer specific screening
- · Up-screening capabilities

- Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- · Application and design sample kits
- Custom product and package development

REQUESTING PRODUCT PLATING

- 1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
- 2. If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

CONTACT US

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www.centralsemi.com

Worldwide Field Representatives: www.centralsemi.com/wwreps

Worldwide Distributors:

www.centralsemi.com/wwdistributors

For the latest version of Central Semiconductor's **LIMITATIONS AND DAMAGES DISCLAIMER**, which is part of Central's Standard Terms and Conditions of sale, visit: www.centralsemi.com/terms

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Product End of Life Notification

PDN ID:	PDN01124
Notification Date:	4/18/19
Last Buy Date:	10/18/19
Last Shipment Date	4/18/20

Summary: The CP373 wafer process is being discontinued and is now classified as End of Life (EOL). The replacement wafer process is CP398X.

Although Central Semiconductor Corp. makes every effort to continue to produce devices that have been proclaimed EOL (End of Life) by other manufacturers, it is an accepted industry practice to discontinue certain devices when customer demand falls below a minimum level of sustainability. Accordingly, the following product(s) have been transitioned to End of Life status as part of Central's ongoing Product Management Process. Any replacement products are noted below. The effective date for placing last purchase orders will be six (6) months from the date of this notice and twelve (12) months from the notice date for final shipments, and minimum order quantities may apply. The last purchase and shipment dates may be extended if inventory is available.

Central Part Number	Replacement
CP373-CMPDM303-CT20	CP398X-CPDM303-CT20
CP373-CMPDM303NH-CT	CP398X-CPDM303NH-CT
CP373-CMPDM303NH-WN	CP398X-CPDM303NH-WN
CP373-CTLDM303N-CT	CP398X-CTLDM303N-CT
CP373-CTLDM303N-WN	CP398X-CTLDM303N-WN

Central would be happy to assist you by providing additional information or technical data to help locate an alternate source if we have no replacement available. Please email your requests to engineering@centralsemi.com.

DISCLAIMER: This End of Life (EOL) notification is in accordance with JEDEC standard JESD48 - Product Discontinuance. Central Semiconductor Corp. will make every effort to offer life-time buy (LTB) opportunities and/or offer replacement devices to existing customers for discontinued devices, however, one or both may not be possible for all devices. Please contact your local Central Semiconductor sales representative for LTB opportunities/additional information.

CCC785 REV 002